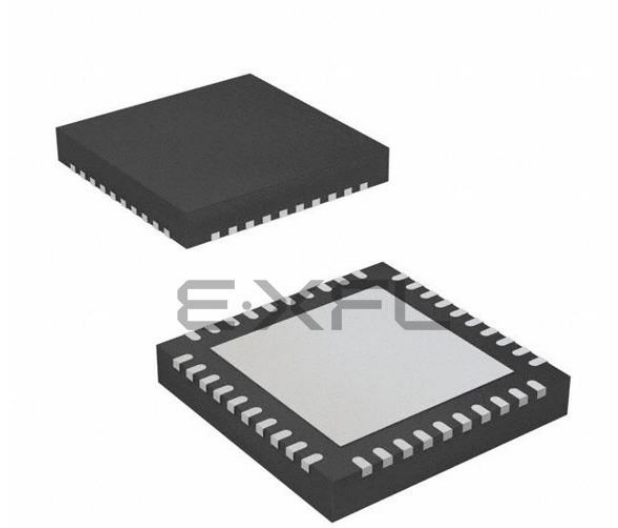

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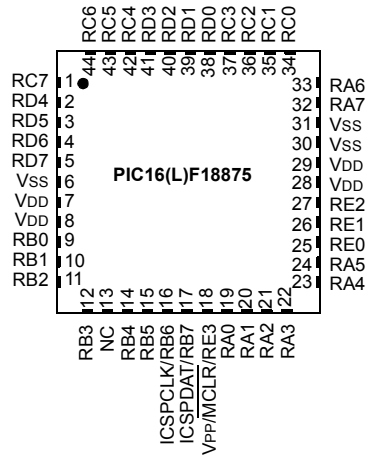
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f18875-e-mv

44-pin QFN (8x8)



Note 1: See Table 3 for location of all peripheral functions.

2: All VDD and all VSS pins must be connected at the circuit board level. Allowing one or more VSS or VDD pins to float may result in degraded electrical performance or non-functionality.

3: The bottom pad of the QFN/UQFN package should be connected to VSS at the circuit board level.

TABLE 1-3: PIC16F18875 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC0/ANC0/T1CKI(1)/T3CKI(1)/T3G(1)/ SMTWIN1(1)/IOCC0/SOSCO	RC0	TTL/ST	CMOS/OD	General purpose I/O.
	ANC0	AN	—	ADC Channel C0 input.
	T1CKI(1)	TTL/ST	—	Timer1 external digital clock input.
	T3CKI(1)	TTL/ST	—	Timer3 external digital clock input.
	T3G(1)	TTL/ST	—	Timer3 gate input.
	SMTWIN1(1)	TTL/ST	—	Signal Measurement Timer1 (SMT1) input.
	IOCC0	TTL/ST	—	Interrupt-on-change input.
	SOSCO	—	AN	32.768 kHz secondary oscillator crystal driver output.
RC1/ANC1/SMTSIG1(1)/CCP2(1)/ IOCC1/SOSCI	RC1	TTL/ST	CMOS/OD	General purpose I/O.
	ANC1	AN	—	ADC Channel C1 input.
	SMTSIG1(1)	TTL/ST	—	Signal Measurement Timer1 (SMT1) signal input.
	CCP2(1)	TTL/ST	CMOS/OD	Capture/compare/PWM2 (default input location for capture function).
	IOCC1	TTL/ST	—	Interrupt-on-change input.
	SOSCI	AN	—	32.768 kHz secondary oscillator crystal driver input.
RC2/ANC2/T5CKI(1)/CCP1(1)/IOCC2	RC2	TTL/ST	CMOS/OD	General purpose I/O.
	ANC2	AN	—	ADC Channel C2 input.
	T5CKI(1)	TTL/ST	—	Timer5 external digital clock input.
	CCP1(1)	TTL/ST	CMOS/OD	Capture/compare/PWM1 (default input location for capture function).
	IOCC2	TTL/ST	—	Interrupt-on-change input.
RC3/ANC3/SCL1(3,4)/SCK1(1)/ T2IN(1)/IOCC3	RC3	TTL/ST	CMOS/OD	General purpose I/O.
	ANC3	AN	—	ADC Channel C3 input.
	SCL1(3,4)	I^2C/SMBus	OD	MSSP1 I^2C clock input/output.
	SCK1(1)	TTL/ST	CMOS/OD	MSSP1 SPI clock input/output (default input location, SCK1 is a PPS remappable input and output).
	T2IN(1)	TTL/ST	—	Timer2 external input.
	IOCC3	TTL/ST	—	Interrupt-on-change input.
RC4/ANC4/SDA1(3,4)/SDI1(1)/IOCC4	RC4	TTL/ST	CMOS/OD	General purpose I/O.
	ANC4	AN	—	ADC Channel C4 input.
	SDA1(3,4)	I^2C/SMBus	OD	MSSP1 I^2C serial data input/output.
	SDI1(1)	TTL/ST	—	MSSP1 SPI serial data input.
	IOCC4	TTL/ST	—	Interrupt-on-change input.
RC5/ANC5/T4IN(1)/IOCC5	RC5	TTL/ST	CMOS/OD	General purpose I/O.
	ANC5	AN	—	ADC Channel C5 input.
	T4IN(1)	TTL/ST	—	Timer4 external input.
	IOCC5	TTL/ST	—	Interrupt-on-change input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2CHV= High Voltage XTAL= Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 13-1 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 13-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

TABLE 3-13: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	PIC16(L)F18855	PIC16(L)F18875	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 3													
CPU CORE REGISTERS; see Table 3-2 for specifics													
18Ch	SSP1BUF			SSPBUF<7:0>								xxxx xxxx	xxxx xxxx
18Dh	SSP1ADD			SSPADD<7:0>								0000 0000	0000 0000
18Eh	SSP1MSK			SSPMSK<7:0>								1111 1111	1111 1111
18Fh	SSP1STAT			SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000	0000 0000
190h	SSP1CON1			WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				0000 0000	0000 0000
191h	SSP1CON2			GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
192h	SSP1CON3			ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000 0000	0000 0000
193h	—	—		Unimplemented								—	—
194h	—	—		Unimplemented								—	—
195h	—	—		Unimplemented								—	—
196h	SSP2BUF			SSPBUF<7:0>								xxxx xxxx	xxxx xxxx
197h	SSP2ADD			SSPADD<7:0>								0000 0000	0000 0000
198h	SSP2MSK			SSPMSK<7:0>								1111 1111	1111 1111
199h	SSP2STAT			SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000	0000 0000
19Ah	SSP2CON1			WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				0000 0000	0000 0000
19Bh	SSP2CON2			GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
19Ch	SSP2CON3			ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000 0000	0000 0000
19Dh	—	—		Unimplemented								—	—
19Eh	—	—		Unimplemented								—	—
19Fh	—	—		Unimplemented								—	—

Legend: x = unknown, u = unchanged, q =depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Register present on PIC16F18855/75 devices only.

2: Unimplemented, read as '1'.

TABLE 3-13: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	PIC16(L)F18855	PIC16(L)F18875	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 18													
CPU CORE REGISTERS; see Table 3-2 for specifics													
90Ch	FVRCON			FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		0q00 0000	0q00 0000
90Dh	—	—		Unimplemented								—	—
90Eh	DAC1CON0			DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	DAC1NSS	0-0- 00--	0-0- 00--
90Fh	DAC1CON1			—	—	—	DAC1R<4:0>					---0 0000	---0 0000
910h	—	—		Unimplemented								—	—
911h	—	—		Unimplemented								—	—
912h	—	—		Unimplemented								—	—
913h	—	—		Unimplemented								—	—
914h	—	—		Unimplemented								—	—
915h	—	—		Unimplemented								—	—
916h	—	—		Unimplemented								—	—
917h	—	—		Unimplemented								—	—
918h	—	—		Unimplemented								—	—
919h	—	—		Unimplemented								—	—
91Ah	—	—		Unimplemented								—	—
91Bh	—	—		Unimplemented								—	—
91Ch	—	—		Unimplemented								—	—
91Dh	—	—		Unimplemented								—	—
91Eh	—	—		Unimplemented								—	—
91Fh	ZCDCON			EN	—	OUT	POL	—	—	INTP	INTN	0-x0 --00	0-x0 --00

Legend: x = unknown, u = unchanged, q =depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Register present on PIC16F18855/75 devices only.

2: Unimplemented, read as '1'.

TABLE 3-13: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	PIC16(L)F18855	PIC16(L)F18875	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 30 (Continued)													
F24h	RC4PPS			—	—	RC4PPS<5:0>						--00 0000	--uu uuuu
F25h	RC5PPS			—	—	RC5PPS<5:0>						--00 0000	--uu uuuu
F26h	RC6PPS			—	—	RC6PPS<5:0>						--00 0000	--uu uuuu
F27h	RC7PPS			—	—	RC7PPS<5:0>						--00 0000	--uu uuuu
F28h	RD0PPS	—	X	—	—	RD0PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F29h	RD1PPS	—	X	—	—	RD1PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Ah	RD2PPS	—	X	—	—	RD2PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Bh	RD3PPS	—	X	—	—	RD3PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Ch	RD4PPS	—	X	—	—	RD4PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Dh	RD5PPS	—	X	—	—	RD5PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Eh	RD6PPS	—	X	—	—	RD6PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F2Fh	RD7PPS	—	X	—	—	RD7PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F30h	RE0PPS	—	X	—	—	RE0PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----

Legend: x = unknown, u = unchanged, q =depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

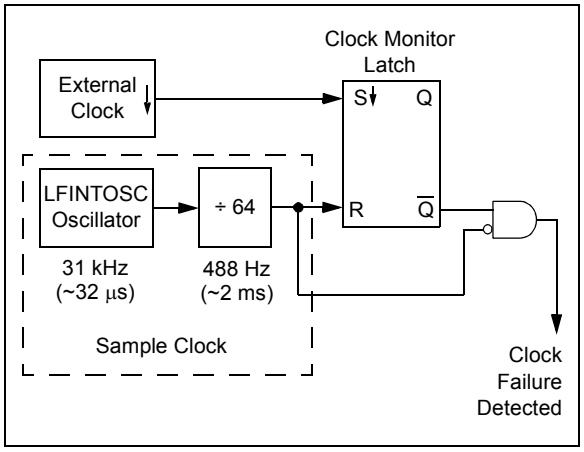
Note 1: Register present on PIC16F18855/75 devices only.

2: Unimplemented, read as '1'.

6.4 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the device to continue operating should the external oscillator fail. The FSCM is enabled by setting the FCMEN bit in the Configuration Words. The FSCM is applicable to all external Oscillator modes (LP, XT, HS, EC and Secondary Oscillator).

FIGURE 6-9: FSCM BLOCK DIAGRAM



6.4.1 FAIL-SAFE DETECTION

The FSCM module detects a failed oscillator by comparing the external oscillator to the FSCM sample clock. The sample clock is generated by dividing the LFINTOSC by 64. See Figure 6-9. Inside the fail detector block is a latch. The external clock sets the latch on each falling edge of the external clock. The sample clock clears the latch on each rising edge of the sample clock. A failure is detected when an entire half-cycle of the sample clock elapses before the external clock goes low.

6.4.2 FAIL-SAFE OPERATION

When the external clock fails, the FSCM switches the device clock to the HFINTOSC at 1 MHz clock frequency and sets the bit flag OSFIF of the PIR1 register. Setting this flag will generate an interrupt if the OSFIE bit of the PIE1 register is also set. The device firmware can then take steps to mitigate the problems that may arise from a failed clock. The system clock will continue to be sourced from the internal clock source until the device firmware successfully restarts the external oscillator and switches back to external operation, by writing to the NOSC and NDIV bits of the OSCCON1 register.

6.4.3 FAIL-SAFE CONDITION CLEARING

The Fail-Safe condition is cleared after a Reset, executing a SLEEP instruction or changing the NOSC and NDIV bits of the OSCCON1 register. When switching to the external oscillator or PLL, the OST is restarted. While the OST is running, the device continues to operate from the INTOSC selected in OSCCON1. When the OST times out, the Fail-Safe condition is cleared after successfully switching to the external clock source. The OSFIF bit should be cleared prior to switching to the external clock source. If the Fail-Safe condition still exists, the OSFIF flag will again become set by hardware.

REGISTER 7-18: PIR6: PERIPHERAL INTERRUPT REQUEST REGISTER 6

U-0	U-0	U-0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
—	—	—	CCP5IF	CCP4IF	CCP3IF	CCP2IF	CCP1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **CCP5IF:** CCP5 Interrupt Flag bit
CCP5IF = 1:
Capture mode: Capture occurred (must be cleared in software)
Compare mode: Compare match occurred (must be cleared in software)
PWM mode: Output trailing edge occurred (must be cleared in software)
CCP5IF = 0:
Capture mode: Capture did not occur
Compare mode: Compare match did not occur
PWM mode: Output trailing edge did not occur

bit 3 **CCP4IF:** CCP4 Interrupt Flag bit
CCP4IF = 1:
Capture mode: Capture occurred (must be cleared in software)
Compare mode: Compare match occurred (must be cleared in software)
PWM mode: Output trailing edge occurred (must be cleared in software)
CCP4IF = 0:
Capture mode: Capture did not occur
Compare mode: Compare match did not occur
PWM mode: Output trailing edge did not occur

bit 2 **CCP3IF:** CCP3 Interrupt Flag bit
CCP3IF = 1:
Capture mode: Capture occurred (must be cleared in software)
Compare mode: Compare match occurred (must be cleared in software)
PWM mode: Output trailing edge occurred (must be cleared in software)
CCP3IF = 0:
Capture mode: Capture did not occur
Compare mode: Compare match did not occur
PWM mode: Output trailing edge did not occur

bit 1 **CCP2IF:** CCP2 Interrupt Flag bit
CCP2IF = 1:
Capture mode: Capture occurred (must be cleared in software)
Compare mode: Compare match occurred (must be cleared in software)
PWM mode: Output trailing edge occurred (must be cleared in software)
CCP2IF = 0:
Capture mode: Capture did not occur
Compare mode: Compare match did not occur
PWM mode: Output trailing edge did not occur

bit 0 **CCP1IF:** CCP1 Interrupt Flag bit
CCP1IF = 1:
Capture mode: Capture occurred (must be cleared in software)
Compare mode: Compare match occurred (must be cleared in software)
PWM mode: Output trailing edge occurred (must be cleared in software)
CCP1IF = 0:
Capture mode: Capture did not occur
Compare mode: Compare match did not occur
PWM mode: Output trailing edge did not occur

TABLE 7-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIE0	—	—	TMR0IE	IOCIE	—	—	—	INTE	135
PIE1	OSFIE	CSWIE	—	—	—	—	ADTIE	ADIE	136
PIE2	—	ZCDIE	—	—	—	—	C2IE	C1IE	137
PIE3	—	—	RCIE	TXIE	BCL2IE	SSP2IE	BCL1IE	SSP1IE	138
PIE4	—	—	TMR6IE	TMR5IE	TMR4IE	TMR3IE	TMR2IE	TMR1IE	139
PIE5	CLC4IE	CLC3IE	CLC2IE	CLC1IE	—	TMR5GIE	TMR3GIE	TMR1GIE	140
PIE6	—	—	—	CCP5IE	CCP4IE	CCP3IE	CCP2IE	CCP1IE	141
PIE7	SCANIE	CRCIE	NVMIE	NCO1IE	—	CWG3IE	CWG2IE	CWG1IE	142
PIE8	—	—	SMT2PWAIE	SMT2PRAIE	SMT2IE	SMT1PWAIE	SMT1PRAIE	SMT1IE	143
PIR0	—	—	TMR0IF	IOCIF	—	—	—	INTF	144
PIR1	OSFIF	CSWIF	—	—	—	—	ADTIF	ADIF	145
PIR2	—	ZCDIF	—	—	—	—	C2IF	C1IF	146
PIR3	—	—	RCIF	TXIF	BCL2IF	SSP2IF	BCL1IF	SSP1IF	147
PIR4	—	—	TMR6IF	TMR5IF	TMR4IF	TMR3IF	TMR2IF	TMR1IF	148
PIR5	CLC4IF	CLC3IF	CLC2IF	CLC1IF	—	TMR5GIF	TMR3GIF	TMR1GIF	149
PIR6	—	—	—	CCP5IF	CCP4IF	CCP3IF	CCP2IF	CCP1IF	150
PIR7	SCANIF	CRCIF	NVMIF	NCO1IF	—	CWG3IF	CWG2IF	CWG1IF	152
PIR8	—	—	SMT2PWAIF	SMT2PRAIF	SMT2IF	SMT1PWAIF	SMT1PRAIF	SMT1IF	153

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by interrupts.

9.1 Independent Clock Source

The WDT can derive its time base from either the 31 kHz LFINTOSC or 31.25 kHz MFINTOSC/16 internal oscillators, depending on the value of either the WDTCCS<2:0> Configuration bits or the WDTCS<2:0> bits of WDTCON1. Time intervals in this chapter are based on a minimum nominal interval of 1 ms. See **Section 37.0 "Electrical Specifications"** for LFINTOSC and MFINTOSC tolerances.

9.2 WDT Operating Modes

The Watchdog Timer module has four operating modes controlled by the WDTE<1:0> bits in Configuration Words. See Table 9-1.

9.2.1 WDT IS ALWAYS ON

When the WDTE bits of Configuration Words are set to '11', the WDT is always on.

WDT protection is active during Sleep.

9.2.2 WDT IS OFF IN SLEEP

When the WDTE bits of Configuration Words are set to '10', the WDT is on, except in Sleep.

WDT protection is not active during Sleep.

9.2.3 WDT CONTROLLED BY SOFTWARE

When the WDTE bits of Configuration Words are set to '01', the WDT is controlled by the SEN bit of the WDTCON0 register.

WDT protection is unchanged by Sleep. See Table 9-1 for more details.

TABLE 9-1: WDT OPERATING MODES

WDTE<1:0>	SEN	Device Mode	WDT Mode
11	X	X	Active
10	X	Awake	Active
		Sleep	Disabled
01	1	X	Active
	0	X	Disabled
00	X	X	Disabled

9.3 Time-Out Period

The WDTPS bits of the WDTCON0 register set the time-out period from 1 ms to 256 seconds (nominal). After a Reset, the default time-out period is two seconds.

9.4 Watchdog Window

The Watchdog Timer has an optional Windowed mode that is controlled by the WDTCWS<2:0> Configuration bits and WINDOW<2:0> bits of the WDTCON1 register. In the Windowed mode, the CLRWDT instruction must occur within the allowed window of the WDT period. Any CLRWDT instruction that occurs outside of this window will trigger a window violation and will cause a WDT Reset, similar to a WDT time out. See Figure 9-2 for an example.

The window size is controlled by the WDTCWS<2:0> Configuration bits, or the WINDOW<2:0> bits of WDTCON1, if WDTCWS<2:0> = 111.

In the event of a window violation, a Reset will be generated and the WDTWV bit of the PCON register will be cleared. This bit is set by a POR or can be set in firmware.

9.5 Clearing the WDT

The WDT is cleared when any of the following conditions occur:

- Any Reset
- Valid CLRWDT instruction is executed
- Device enters Sleep
- Device wakes up from Sleep
- WDT is disabled
- Oscillator Start-up Timer (OST) is running
- Any write to the WDTCON0 or WDTCON1 registers

9.5.1 CLRWDT CONSIDERATIONS (WINDOWED MODE)

When in Windowed mode, the WDT must be armed before a CLRWDT instruction will clear the timer. This is performed by reading the WDTCON0 register. Executing a CLRWDT instruction without performing such an arming action will trigger a window violation.

See Table 9-2 for more information.

9.6 Operation During Sleep

When the device enters Sleep, the WDT is cleared. If the WDT is enabled during Sleep, the WDT resumes counting. When the device exits Sleep, the WDT is cleared again.

The WDT remains clear until the OST, if enabled, completes. See **Section 6.0 "Oscillator Module (with Fail-Safe Clock Monitor)"** for more information on the OST.

When a WDT time-out occurs while the device is in Sleep, no Reset is generated. Instead, the device wakes up and resumes operation. The TO and PD bits in the STATUS register are changed to indicate the event. The RWDT bit in the PCON register can also be used. See **Section 3.0 "Memory Organization"** for more information.

10.4.5 NVMREG WRITE TO PFM

Program memory is programmed using the following steps:

1. Load the address of the row to be programmed into NVMADRH:NVMADRL.
2. Load each write latch with data.
3. Initiate a programming operation.
4. Repeat steps 1 through 3 until all data is written.

Before writing to program memory, the word(s) to be written must be erased or previously unwritten. Program memory can only be erased one row at a time. No automatic erase occurs upon the initiation of the write.

Program memory can be written one or more words at a time. The maximum number of words written at one time is equal to the number of write latches. See Figure 10-4 (row writes to program memory with 32 write latches) for more details.

The write latches are aligned to the Flash row address boundary defined by the upper ten bits of NVMADRH:NVMADRL, (NVMADRH<6:0>:NVMADRL<7:5>) with the lower five bits of NVMADRL, (NVMADRL<4:0>) determining the write latch being loaded. Write operations do not cross these boundaries. At the completion of a program memory write operation, the data in the write latches is reset to contain 0x3FFF.

The following steps should be completed to load the write latches and program a row of program memory. These steps are divided into two parts. First, each write latch is loaded with data from the NVMDATH:NVMDATL using the unlock sequence with LWLO = 1. When the last word to be loaded into the write latch is ready, the LWLO bit is cleared and the unlock sequence executed. This initiates the programming operation, writing all the latches into Flash program memory.

Note:	The special unlock sequence is required to load a write latch with data or initiate a Flash programming operation. If the unlock sequence is interrupted, writing to the latches or program memory will not be initiated.

1. Set the WREN bit of the NVMCON1 register.
2. Clear the NVMREGS bit of the NVMCON1 register.
3. Set the LWLO bit of the NVMCON1 register. When the LWLO bit of the NVMCON1 register is '1', the write sequence will only load the write latches and will not initiate the write to Flash program memory.
4. Load the NVMADRH:NVMADRL register pair with the address of the location to be written.
5. Load the NVMDATH:NVMDATL register pair with the program memory data to be written.
6. Execute the unlock sequence (**Section 10.4.2 "NVM Unlock Sequence"**). The write latch is now loaded.
7. Increment the NVMADRH:NVMADRL register pair to point to the next location.
8. Repeat steps 5 through 7 until all but the last write latch has been loaded.
9. Clear the LWLO bit of the NVMCON1 register. When the LWLO bit of the NVMCON1 register is '0', the write sequence will initiate the write to Flash program memory.
10. Load the NVMDATH:NVMDATL register pair with the program memory data to be written.
11. Execute the unlock sequence (**Section 10.4.2 "NVM Unlock Sequence"**). The entire program memory latch content is now written to Flash program memory.

Note:	The program memory write latches are reset to the blank state (0x3FFF) at the completion of every write or erase operation. As a result, it is not necessary to load all the program memory write latches. Unloaded latches will remain in the blank state.

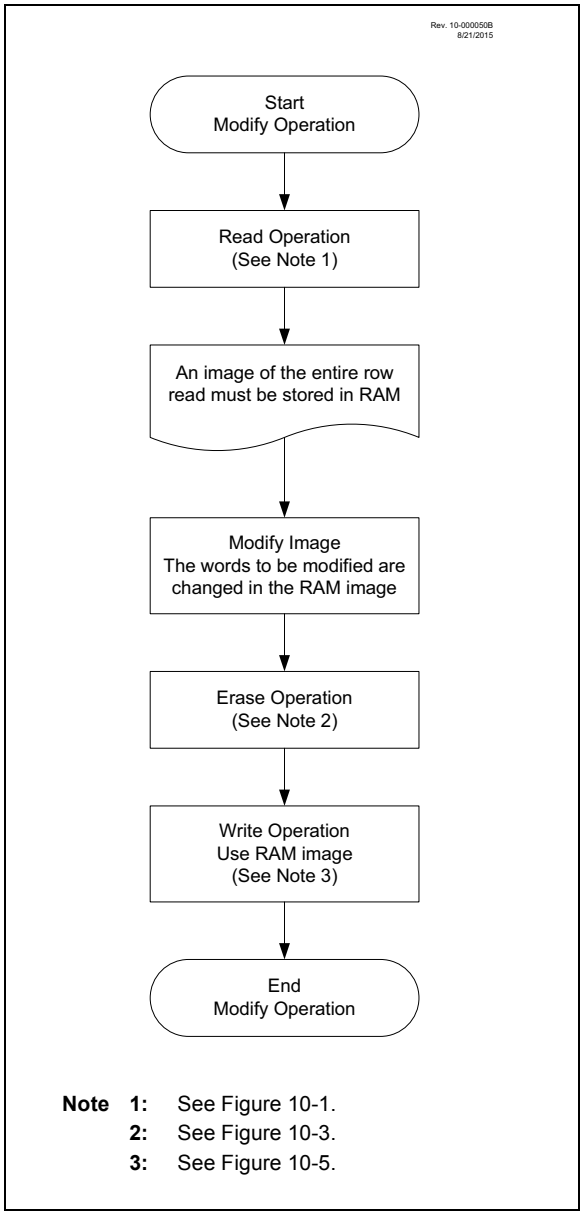
An example of the complete write sequence is shown in Example 10-4. The initial address is loaded into the NVMADRH:NVMADRL register pair; the data is loaded using indirect addressing.

10.4.6 MODIFYING FLASH PROGRAM MEMORY

When modifying existing data in a program memory row, and data within that row must be preserved, it must first be read and saved in a RAM image. Program memory is modified using the following steps:

1. Load the starting address of the row to be modified.
2. Read the existing data from the row into a RAM image.
3. Modify the RAM image to contain the new data to be written into program memory.
4. Load the starting address of the row to be rewritten.
5. Erase the program memory row.
6. Load the write latches with data from the RAM image.
7. Initiate a programming operation.

FIGURE 10-6: FLASH PROGRAM MEMORY MODIFY FLOWCHART



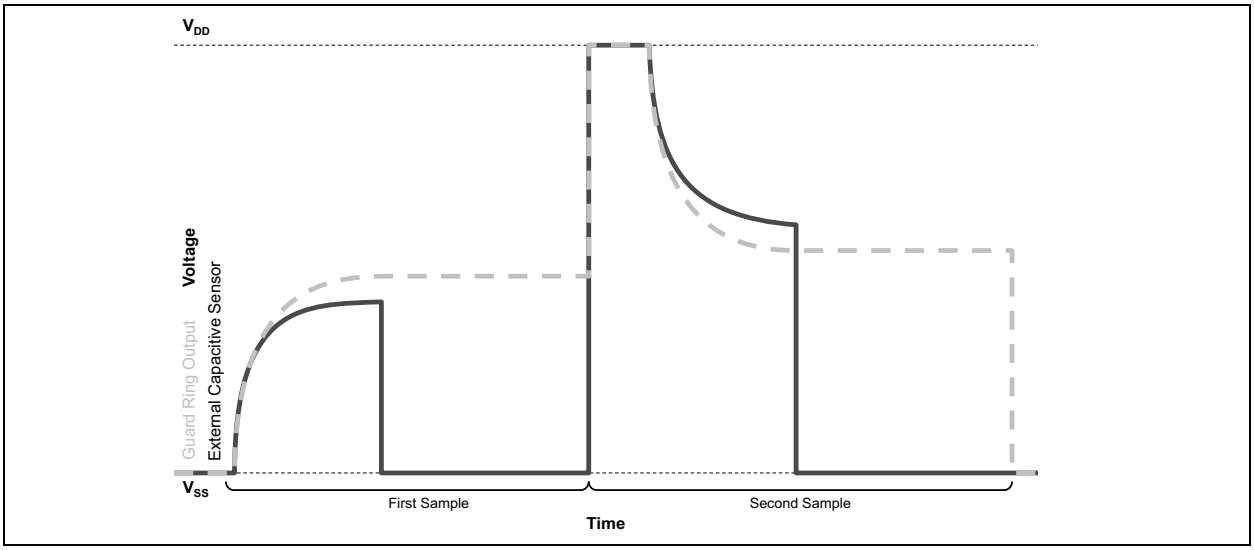
Note 1: See Figure 10-1.
2: See Figure 10-3.
3: See Figure 10-5.

TABLE 22-4: SUMMARY OF REGISTERS ASSOCIATED WITH CLCx

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIR5	CLC4IF	CLC3IF	CLC2IF	CLC1IF	—	TMR5GIF	TMR3GIF	TMR1GIF	149
PIE5	CLC4IE	CLC4IE	CLC2IE	CLC1IE	—	TMR5GIE	TMR3GIE	TMR1GIE	140
CLC1CON	LC1EN	—	LC1OUT	LC1INTP	LC1INTN	LC1MODE<2:0>			327
CLC1POL	LC1POL	—	—	—	LC1G4POL	LC1G3POL	LC1G2POL	LC1G1POL	328
CLC1SEL0	—	—	LC1D1S<5:0>						329
CLC1SEL1	—	—	LC1D2S<5:0>						329
CLC1SEL2	—	—	LC1D3S<5:0>						329
CLC1SEL3	—	—	LC1D4S<5:0>						329
CLC1GLS0	LC1G1D4T	LC1G1D4N	LC1G1D3T	LC1G1D3N	LC1G1D2T	LC1G1D2N	LC1G1D1T	LC1G1D1N	330
CLC1GLS1	LC1G2D4T	LC1G2D4N	LC1G2D3T	LC1G2D3N	LC1G2D2T	LC1G2D2N	LC1G2D1T	LC1G2D1N	331
CLC1GLS2	LC1G3D4T	LC1G3D4N	LC1G3D3T	LC1G3D3N	LC1G3D2T	LC1G3D2N	LC1G3D1T	LC1G3D1N	332
CLC1GLS3	LC1G4D4T	LC1G4D4N	LC1G4D3T	LC1G4D3N	LC1G4D2T	LC1G4D2N	LC1G4D1T	LC1G4D1N	333
CLC2CON	LC2EN	—	LC2OUT	LC2INTP	LC2INTN	LC2MODE<2:0>			327
CLC2POL	LC2POL	—	—	—	LC2G4POL	LC2G3POL	LC2G2POL	LC2G1POL	328
CLC2SEL0	—	—	LC2D1S<5:0>						329
CLC2SEL1	—	—	LC2D2S<5:0>						329
CLC2SEL2	—	—	LC2D3S<5:0>						329
CLC2SEL3	—	—	LC2D4S<5:0>						329
CLC2GLS0	LC2G1D4T	LC2G1D4N	LC2G1D3T	LC2G1D3N	LC2G1D2T	LC2G1D2N	LC2G1D1T	LC2G1D1N	330
CLC2GLS1	LC2G2D4T	LC2G2D4N	LC2G2D3T	LC2G2D3N	LC2G2D2T	LC2G2D2N	LC2G2D1T	LC2G2D1N	331
CLC2GLS2	LC2G3D4T	LC2G3D4N	LC2G3D3T	LC2G3D3N	LC2G3D2T	LC2G3D2N	LC2G3D1T	LC2G3D1N	332
CLC2GLS3	LC2G4D4T	LC2G4D4N	LC2G4D3T	LC2G4D3N	LC2G4D2T	LC2G4D2N	LC2G4D1T	LC2G4D1N	333
CLC3CON	LC3EN	—	LC3OUT	LC3INTP	LC3INTN	LC3MODE<2:0>			327
CLC3POL	LC3POL	—	—	—	LC3G4POL	LC3G3POL	LC3G2POL	LC3G1POL	328
CLC3SEL0	—	—	LC3D1S<5:0>						329
CLC3SEL1	—	—	LC3D2S<5:0>						329
CLC3SEL2	—	—	LC3D3S<5:0>						329
CLC3SEL3	—	—	LC3D4S<5:0>						329
CLC3GLS0	LC3G1D4T	LC3G1D4N	LC3G1D3T	LC3G1D3N	LC3G1D2T	LC3G1D2N	LC3G1D1T	LC3G1D1N	330
CLC3GLS1	LC3G2D4T	LC3G2D4N	LC3G2D3T	LC3G2D3N	LC3G2D2T	LC3G2D2N	LC3G2D1T	LC3G2D1N	331
CLC3GLS2	LC3G3D4T	LC3G3D4N	LC3G3D3T	LC3G3D3N	LC3G3D2T	LC3G3D2N	LC3G3D1T	LC3G3D1N	332
CLC3GLS3	LC3G4D4T	LC3G4D4N	LC3G4D3T	LC3G4D3N	LC3G4D2T	LC3G4D2N	LC3G4D1T	LC3G4D1N	333
CLC4CON	LC4EN	—	LC4OUT	LC4INTP	LC4INTN	LC4MODE<2:0>			327
CLC4POL	LC4POL	—	—	—	LC4G4POL	LC4G3POL	LC4G2POL	LC4G1POL	328
CLC4SEL0	—	—	LC4D1S<5:0>						329
CLC4SEL1	—	—	LC4D2S<5:0>						329
CLC4SEL2	—	—	LC4D3S<5:0>						329
CLC4SEL3	—	—	LC4D4S<5:0>						329
CLC4GLS0	LC4G1D4T	LC4G1D4N	LC4G1D3T	LC4G1D3N	LC4G1D2T	LC4G1D2N	LC4G1D1T	LC4G1D1N	330

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the CLCx modules.

FIGURE 23-9: DIFFERENTIAL CVD WITH GUARD RING OUTPUT WAVEFORM



REGISTER 23-16: ADRESH: ADC RESULT REGISTER HIGH, ADFRM=0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<9:2>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADRES<9:2>**: ADC Result Register bits
Most Significant eight bits of 10-bit conversion result.

REGISTER 23-17: ADRESL: ADC RESULT REGISTER LOW, ADFRM=0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<1:0>		—	—	—	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **ADRES<1:0>**: ADC Result Register bits. Least Significant two bits of 10-bit conversion result.
bit 5-0 **Reserved**: Do not use.

REGISTER 23-18: ADRESH: ADC RESULT REGISTER HIGH, ADFRM=1

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	—	—	ADRES<9:8>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-2 **Reserved**: Do not use.
bit 1-0 **ADRES<9:8>**: ADC Sample Result bits. Most Significant two bits of 10-bit conversion result.

REGISTER 23-24: ADSTPTH: ADC THRESHOLD SETPOINT REGISTER HIGH

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADSTPT<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADSTPT<15:8>**: ADC Threshold Setpoint MSB. Most Significant Byte of ADC threshold setpoint, depending on ADCALC, may be used to determine ADERR, see Register 21-1 for more details.

\

REGISTER 23-25: ADSTPTL: ADC THRESHOLD SETPOINT REGISTER LOW

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
ADSTPT<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADSTPT<7:0>**: ADC Threshold Setpoint LSB. Least Significant Byte of ADC threshold setpoint, depending on ADCALC, may be used to determine ADERR, see Register 21-1 for more details.

REGISTER 23-26: ADERRH: ADC CALCULATION ERROR REGISTER HIGH

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ADERR<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADERR<15:8>**: ADC Calculation Error MSB. Most Significant Byte of ADC Calculation Error. Calculation is determined by ADCALC bits of ADCON3, see Register 21-1 for more details.

TABLE 27-1: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER0

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
TMR0L	Holding Register for the Least Significant Byte of the 16-bit TMR0 Register								404*
TMR0H	Holding Register for the Most Significant Byte of the 16-bit TMR0 Register								404*
T0CON0	T0EN	—	T0OUT	T016BIT	T0OUTPS<3:0>				407
T0CON1	T0CS<2:0>			T0ASYNC	T0CKPS<3:0>				408
T0CKIPPS	—	—	—	—	T0CKIPPS<3:0>				249
TMR0PPS	—	—	—	TMR0PPS<4:0>					249
ADACT	—	—	—	ADACT<4:0>					359
CLCxSELy	—	—	—	LCxDyS<4:0>					329
T1GCON	GE	GPOL	GTM	GSPM	GGO/$\overline{\text{DONE}}$	GVAL	—	—	420
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIR0	—	—	TMR0IF	IOCIF	—	—	—	INTF	144
PIE0	—	—	TMR0IE	IOCIE	—	—	—	INTE	135

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used by the Timer0 module.

* Page with Register information.

REGISTER 31-5: SSPxMSK: SSPx MASK REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SSPMSK<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-1 **SSPMSK<7:1>:** Mask bits
1 = The received address bit n is compared to SSPxADD<n> to detect I^2C address match
0 = The received address bit n is not used to detect I^2C address match

bit 0 **SSPMSK<0>:** Mask bit for I^2C Slave mode, 10-bit Address
I^2C Slave mode, 10-bit address (SSPM<3:0> = 0111 or 1111):
1 = The received address bit 0 is compared to SSPxADD<0> to detect I^2C address match
0 = The received address bit 0 is not used to detect I^2C address match
I^2C Slave mode, 7-bit address:
MSK0 bit is ignored.

REGISTER 31-6: SSPxADD: MSSPx ADDRESS AND BAUD RATE REGISTER (I^2C MODE)

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
SSPADD<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

Master mode:

bit 7-0 **SSPADD<7:0>:** Baud Rate Clock Divider bits
SCL pin clock period = ((ADD<7:0> + 1) *4)/FOSC

10-Bit Slave mode – Most Significant Address Byte:

bit 7-3 **Not used:** Unused for Most Significant Address Byte. Bit state of this register is a "don't care". Bit pattern sent by master is fixed by I^2C specification and must be equal to '11110'. However, those bits are compared by hardware and are not affected by the value in this register.

bit 2-1 **SSPADD<2:1>:** Two Most Significant bits of 10-bit Address

bit 0 **Not used:** Unused in this mode. Bit state is a "don't care".

10-Bit Slave mode – Least Significant Address Byte:

bit 7-0 **SSPADD<7:0>:** Eight Least Significant bits of 10-bit Address

7-Bit Slave mode:

bit 7-1 **SSPADD<7:1>:** 7-bit Address

bit 0 **Not used:** Unused in this mode. Bit state is a "don't care".

TABLE 33-4: BAUD RATE FOR ASYNCHRONOUS MODES (CONTINUED)

BAUD RATE	SYNC = 0, BRGH = 1, BRG16 = 0											
	Fosc = 32.000 MHz			Fosc = 20.000 MHz			Fosc = 18.432 MHz			Fosc = 11.0592 MHz		
	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)
300	—	—	—	—	—	—	—	—	—	—	—	—
1200	—	—	—	—	—	—	—	—	—	—	—	—
2400	—	—	—	—	—	—	—	—	—	—	—	—
9600	9615	0.16	207	9615	0.16	129	9600	0.00	119	9600	0.00	71
10417	10417	0.00	191	10417	0.00	119	10378	-0.37	110	10473	0.53	65
19.2k	19.23k	0.16	103	19.23k	0.16	64	19.20k	0.00	59	19.20k	0.00	35
57.6k	57.14k	-0.79	34	56.82k	-1.36	21	57.60k	0.00	19	57.60k	0.00	11
115.2k	117.64k	2.12	16	113.64k	-1.36	10	115.2k	0.00	9	115.2k	0.00	5

BAUD RATE	SYNC = 0, BRGH = 1, BRG16 = 0											
	Fosc = 8.000 MHz			Fosc = 4.000 MHz			Fosc = 3.6864 MHz			Fosc = 1.000 MHz		
	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)
300	—	—	—	—	—	—	—	—	—	300	0.16	207
1200	—	—	—	1202	0.16	207	1200	0.00	191	1202	0.16	51
2400	2404	0.16	207	2404	0.16	103	2400	0.00	95	2404	0.16	25
9600	9615	0.16	51	9615	0.16	25	9600	0.00	23	—	—	—
10417	10417	0.00	47	10417	0.00	23	10473	0.53	21	10417	0.00	5
19.2k	19231	0.16	25	19.23k	0.16	12	19.2k	0.00	11	—	—	—
57.6k	55556	-3.55	8	—	—	—	57.60k	0.00	3	—	—	—
115.2k	—	—	—	—	—	—	115.2k	0.00	1	—	—	—

BAUD RATE	SYNC = 0, BRGH = 0, BRG16 = 1											
	Fosc = 32.000 MHz			Fosc = 20.000 MHz			Fosc = 18.432 MHz			Fosc = 11.0592 MHz		
	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)	Actual Rate	% Error	SPBRG value (decimal)
300	300.0	0.00	6666	300.0	-0.01	4166	300.0	0.00	3839	300.0	0.00	2303
1200	1200	-0.02	3332	1200	-0.03	1041	1200	0.00	959	1200	0.00	575
2400	2401	-0.04	832	2399	-0.03	520	2400	0.00	479	2400	0.00	287
9600	9615	0.16	207	9615	0.16	129	9600	0.00	119	9600	0.00	71
10417	10417	0.00	191	10417	0.00	119	10378	-0.37	110	10473	0.53	65
19.2k	19.23k	0.16	103	19.23k	0.16	64	19.20k	0.00	59	19.20k	0.00	35
57.6k	57.14k	-0.79	34	56.818	-1.36	21	57.60k	0.00	19	57.60k	0.00	11
115.2k	117.6k	2.12	16	113.636	-1.36	10	115.2k	0.00	9	115.2k	0.00	5

TABLE 37-14: COMPARATOR SPECIFICATIONS

Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristics**	**Min.**	**Typ.**	**Max.**	**Units**	**Comments**
CM01	VIOFF	Input Offset Voltage	—	—	±30	mV	VICM = VDD/2
CM02	VICM	Input Common Mode Range	GND	—	VDD	V	
CM03	CMRR	Common Mode Input Rejection Ratio	—	50	—	dB	
CM04	VHYST	Comparator Hysteresis	15	25	35	mV	
CM05	TRESP(1)	Response Time, Rising Edge	—	300	600	ns	
		Response Time, Falling Edge	—	220	500	ns	

* These parameters are characterized but not tested.

Note 1: Response time measured with one comparator input at VDD/2, while the other input transitions from VSS to VDD.

2: A mode change includes changing any of the control register values, including module enable.

TABLE 37-15: 5-BIT DAC SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristics**	**Min.**	**Typ.**	**Max.**	**Units**	**Comments**
DSB01	VLSB	Step Size	—	(VDACREF+ -VDACREF-) /32	—	V	
DSB01	VACC	Absolute Accuracy	—	—	± 0.5	LSb	
DSB03*	RUNIT	Unit Resistor Value	—	5000	—	Ω	
DSB04*	TST	Settling Time(1)	—	—	10	µs	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Settling time measured while DACR<4:0> transitions from '00000' to '01111'.

TABLE 37-16: FIXED VOLTAGE REFERENCE (FVR) SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Symbol**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
FVR01	VFVR1	1x Gain (1.024V)	-4	—	+4	%	VDD ≥ 2.5V, -40°C to 85°C
FVR02	VFVR2	2x Gain (2.048V)	-4	—	+4	%	VDD ≥ 2.5V, -40°C to 85°C
FVR03	VFVR4	4x Gain (4.096V)	-5	—	+5	%	VDD ≥ 4.75V, -40°C to 85°C
FVR04	TFVRST	FVR Start-up Time	—	25	—	us	

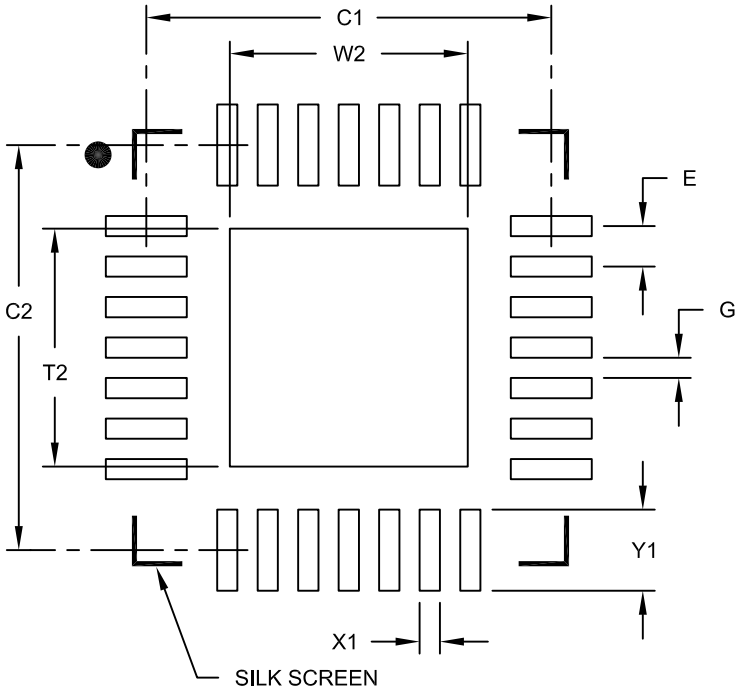
TABLE 37-17: ZERO CROSS DETECT (ZCD) SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristics**	**Min**	**Typ†**	**Max**	**Units**	**Comments**
ZC01	VPINZC	Voltage on Zero Cross Pin	—	0.75	—	V	
ZC02	IZCD_MAX	Maximum source or sink current	—	—	600	µA	
ZC03	TRESPH	Response Time, Rising Edge	—	1	—	µs	
	TRESPL	Response Time, Falling Edge	—	1	—	µs	

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) - 4x4 mm Body [UQFN]
With 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Optional Center Pad Width	W2			2.35
Optional Center Pad Length	T2			2.35
Contact Pad Spacing	C1		4.00	
Contact Pad Spacing	C2		4.00	
Contact Pad Width (X28)	X1			0.20
Contact Pad Length (X28)	Y1			0.80
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2152A